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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KUEI-MING CHANG	06/23/2017
REI-JAY HSIEH	06/23/2017
CHENG-HAN WU	06/23/2017
CHIE-IUAN LIN	06/23/2017

RECEIVING PARTY DATA

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City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	300	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	16933088	

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ATTORNEY DOCKET NUMBER:	2519-0548PUS1	
NAME OF SUBMITTER:	SPENCER GARTH	
SIGNATURE:	/spencer garth/	
DATE SIGNED:	GNED: 07/21/2020	
	•	

Total Attachments: 2

PATENT REEL: 053267 FRAME: 0912 source=2020-07-20_AssgnAsFiled_2519-0548PUS1#page1.tif source=2020-07-20_AssgnAsFiled_2519-0548PUS1#page2.tif

PATENT REEL: 053267 FRAME: 0913

Attorney Docket No. 2519-0548PUS1

NP-20195-US/P20161893US00

Inventor(s)-to-Assignee

ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title)
SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF
The PATENT RIGHTS referred to in this agreement are:
(check one) a patent application for this invention, executed by the ASSIGNOR(S)
concurrently with this assignment.
U.S. patent application Serial No,filed
☐a U.S. patent application based on PCT International Application
Nofiled on (date)(U.S. patent application
Serial No, if known).
U.S. patent No, issued
The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of
the patents and patent applications identified above.
The PATENT RIGHTS assigned under this agreement are:
(check one) U.S. patent rights only.
Worldwide patent rights. In this case, the assignee shall have the right to
claim the benefit of the filing date of any U.S. or foreign patent application
for this invention.
The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures
appear on page 2 of this Assignment and any Supplemental Sheet(s).
The ASSIGNEE referred to in this agreement is:
(Name of Assignee) TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.
(Address) NO.8, LI-HSIN RD.6, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU,
TAIWAN 300, R.O.C.
The ASSIGNEE is:
(check one) An individual.
A Partnership.
△A Corporation of <u>TAIWAN, R.O.C.</u> (specify state or country)
(other)
The ASSIGNIONS in consideration as \$10.00 million the ASSIGNIES and advanced and
The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and
valuable consideration, receipt of which is acknowledged, hereby assign(s) the following
rights to the ASSIGNEE, its successors and assigns:
the full and exclusive right to the invention;
the entire right, title and interest in and to the PATENT RIGHTS;
the right to sue and recover for any past infringement; and
the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

PATENT REEL: 053267 FRAME: 0914 THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO
ASSIGNEE: TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.
INVENTION TITLE: SEMICONDUCTOR DEVICE AND MANUFACTURING
METHOD THEREOF

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

Kuei-Ming CHANG	Luci-ming Chang	2017/06/23
Name of sole or first inventor	Signature	Date
Rei-Jay HSIEH	tei-Jay Hsieh	2017/06/23
Name of second inventor, if any	Signature	Date
Cheng-Han WU	Chengfor Du	2017.06.23
Name of third inventor, if any	Signature	Date
Chie-Iuan LIN	chie-Ivan En	2.17.6.23
Name of fourth inventor, if any	Signature	Date

PATENT REEL: 053267 FRAME: 0915

RECORDED: 07/21/2020